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Bluetooth[®] 4.2 Stereo Audio Module

Features

- Qualified for Bluetooth v4.2 specifications
- Supports HFP 1.6, HSP 1.2, A2DP 1.3, SPP 1.2 and AVRCP 1.6
- Supports Bluetooth 4.2 dual-mode (BDR/EDR/ BLE) specifications (FW dependent)
- Stand-alone module with on-board PCB antenna and Bluetooth stack
- Supports high resolution up to 24-bit, 96 kHz audio data format
- Supports to connect two hosts with HFP/A2DP profiles simultaneously
- · Supports to connect one host with SPP/BTLE
- Transparent UART mode for seamless serial data over UART interface
- Easy to configure with Windows[®] GUI or directly by external MCU
- Supports firmware field upgrade
- · Supports one microphone
- Castellated surface mount pads for easy and reliable host PCB mounting
- · RoHS compliant
- · Ideal for portable battery operated devices
- Internal battery regulator circuitry

DSP Audio Processing

- Supports 64 kbps A-Law, μ-Law PCM format/ Continuous Variable Slope Delta (CVSD) modulation for SCO channel operation
- Supports 8/16 kHz noise suppression
- Supports 8/16 kHz echo cancellation
- Supports Modified Sub-Band Coding (MSBC) decoder for wide band speech
- Built-in High Definition Clean Audio (HCA) algorithms for both narrow band and wide band speech processing
- Packet loss concealment (PLC)
- Built-in audio effect algorithms to enhance audio streaming
- Supports Serial Copy Management System (SCMS-T) content protection



Audio Codec

- Sub-band Coding (SBC) and optional Advanced Audio Coding (AAC) decoding
- 20-bit digital-to-analog converter (DAC) with 98 dB SNR
- 16-bit analog-to-digital converter (ADC) with 92 dB SNR
- Supports up to 24-bit, 96 kHz I²S digital audio

Peripherals

- Built-in lithium-ion and lithium-polymer battery charger (up to 350 mA)
- Integrated 1.8V and 3V configurable switching regulator and low-dropout (LDO) regulator
- Built-in ADC for battery voltage sense
- An AUX-In port for external audio input
- Three LED drivers
- Multiple I/O pins for control and status

RF/Analog

- Frequency spectrum: 2.402 GHz to 2.480 GHz
- Receive sensitivity: -90 dBm (2 Mbps EDR)
- Class 2 output power (+2 dBm typical)

HCI Interface

• High-speed HCI-UART interface (supports up to 921,600 bps)

MAC/Baseband Processor

- Supports Bluetooth 4.2 dual-mode (FW dependent)
 - BDR/EDR transport for audio, voice and SPP data exchange
 - BLE transport for proprietary transparent service and Apple Notification Center Service (ANCS) data exchange

Operating Condition

- Operating voltage: 3.2V to 4.2V
- Operating temperature: -20°C to +70°C

Compliance

• Bluetooth SIG QDID: 83345

Applications

- · Soundbar and Subwoofer (FW dependent)
- · Bluetooth portable speaker phone
- Multi-speaker (FW dependent)

Description

The BM63 module is a fully qualified Bluetooth v4.2 dual-mode (BDR/EDR/BLE) module for designers to add wireless audio and voice applications to their products. The BM63 module is a Bluetooth Special Interest Group (SIG) certified module that provides a complete wireless solution with a Bluetooth stack and an integrated PCB antenna in a compact surface-mount package.

The BM63 module has an integrated lithium-ion and lithium-polymer battery charger, and a digital audio interface. The module supports HSP, HFP, SPP, A2DP and AVRCP profiles, and AAC and SBC codecs.

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BM63

NOTES:

1.0 DEVICE OVERVIEW

The BM63 module is built around Microchip Technology IS2063 SoC. The IS2063 SoC integrates the Bluetooth 4.2 dual-mode radio transceiver, Power Management Unit (PMU), crystal and DSP. Users can configure the BM63 module by using the UI tool and DSP tool, a Windows-based utility.

Note: The UI and DSP tools are available for download from the Microchip web site at: www.microchip.com/BM63.

Figure 1-1 illustrates a typical example of the BM63 module which is connected to an external MCU and a DSP/codec.

FIGURE 1-1: APPLICATION USING BM63 MODULE







BM63

Figure 1-3 illustrates the Soundbar and Subwoofer applications using the BM63 module and smartphone.

FIGURE 1-3: SOUNDBAR AND SUBWOOFER APPLICATIONS USING BM63 MODULE AND SMARTPHONE



Figure 1-4 illustrates the Multi-speaker application using the BM63 module.



BM63

Table 1-1 provides the key features of the BM63 module.

TABLE 1-1: BM63 KEY FEATURES

Feature	BM63
Application	Multi-speaker/Soundbar/Subwoofer
Stereo/mono	Stereo
Pin count	48
Dimensions (mm ²)	15 x 32
PCB antenna	Yes
Tx power (typical)	2 dBm
Audio DAC output	2 Channel
DAC (single-ended) SNR at 2.8V (dB)	-98
DAC (capless) SNR at 2.8V (dB)	-98
ADC SNR at 2.8V (dB)	-92
I ² S digital interface	Yes
Analog AUX-In	Yes
Mono MIC	1
External audio amplifier interface	Yes
UART	Yes
USB	Yes
LED driver	3
Internal DC-DC step down regulator	Yes
DC 5V adapter input	Yes
Battery charger (350 mA max)	Yes
ADC for thermal charger protection	No
Undervoltage protection (UVP)	No
GPIO	15
Button support	6
NFC (triggered by external NFC)	Yes
EEPROM	Yes
Voice prompt (FW dependent)	8K Sampling Rate, stored in EEPROM with approximately 800 bytes/second
Multi-tone	Yes
DSP sound effect	Yes
BLE	Yes
Bluetooth profiles	
HFP	1.6
AVRCP	1.6
A2DP	1.3
HSP	1.2
SPP	1.2

Figure 1-5 illustrates the pin diagram of the BM63 module.



 Table 1-2 provides the pin description of the BM63 module.

Pin No	Pin Type	Name	Description	
1	I	DR0	I ² S interface: digital left/right data	
2	I/O	RFS0	I ² S interface: left/right clock	
3	I/O	SCLK0	I ² S interface: bit clock	
4	0	DT0	I ² S interface: digital left/right data	
5	0	AOHPR	Right-channel, analog headphone output	
6	0	AOHPM	Headphone common mode output/sense input	
7	0	AOHPL	Left-channel, analog headphone output	
8	I	MIC_N1	MIC1 mono differential analog negative input	
9	Ι	MIC_P1	MIC1 mono differential analog positive input	
10	Р	MIC_BIAS	Electric microphone biasing voltage	
11	I	AIR	Right-channel, single-ended analog input	
12	I	AIL	Left-channel, single-ended analog input	
13	I/O	P1_2	EEPROM clock SCL	
14	I/O	P1_3	EEPROM data SDA	
15	I	RST_N	System Reset (active-low)	
16	I/O	P0_1	 Configurable control or indication pin (Internally pulled-up if configured as an input) FWD key when Class 2 RF (default), active-low Class 1 Tx control signal for external RF Tx/Rx switch, active-high 	
17	I/O	P2_4	 System configuration pin along with P2_0 and EAN pins used to set the module in any one of these modes: Application mode (for normal operation) Test mode (to change EEPROM values) Write Flash mode (to load a new firmware into the module), refer to Table 5-1 	
18	I/O	P0_4	Configurable control or indication pin (Internally pulled-up if configured as an input) • NFC detection pin, active-low • Out_Ind_1	
19	I/O	P1_5	Configurable control or indication pin (Internally pulled-up if configured as an input) • NFC detection pin, active-low • Slide switch detector, active-high • Out_Ind_1 • Multi-SPK Master/Slave mode control (FW dependent)	
20	1	HCI_RXD	HCI-UART data input	
21	0	HCI_TXD	HCI-UART data output	
22	Р	CODEC_VO	Power supply/reference voltage for codec. Do not connect, for internal use only	
23	Р	VDD_IO	I/O positive supply. Do not connect, for internal use only	
24	Р	ADAP_IN	5V power adapter input	

TABLE 1-2: BM63 MODULE PIN DESCRIPTION

TABLE 1-2: BM03 MODULE PIN DESCRIPTION (CONTINUED) Dia Na Dia Tuna				
25		BAI_IN	Battery input. Voltage range: 3.2V to 4.2V. When an external power supply is connected to the ADAP_IN pin, the BAT_IN pin can be left open if battery is not connected.	
26	Р	ADC_IN	Analog input	
27	Р	SYS_PWR	System power output derived from ADAP_IN or BAT_IN	
28	I	MFB	 Multi-Function Button and power-on key UART RX_IND, active-high (used by host MCU to wakeup the Bluetooth system) 	
29	Ι	LED3	LED driver 3	
30	I	LED2	LED driver 2	
31	Ι	LED1	LED driver 1	
32	Р	GND	Ground reference	
33	I/O	P3_7	Configurable control or indication pin (Internally pulled-up if configured as an input) UART TX_IND, active-low (used by Bluetooth system to wakeup the host MCU)	
34	I/O	P3_5	Configurable control or indication pin (Internally pulled-up, if configured as an input) • Slide switch detector, active-high	
35	I/O	P0_0	Configurable control or indication pin (Internally pulled-up if configured as an input) • Slide switch detector, active-high, Out_Ind_0	
36	I/O	P0_3	 Configurable control or indication pin (Internally pulled-up if configured as an input) REV key (default), active-low Buzzer signal output Out_Ind_2 Class 1 Rx Control signal of external RF Tx/Rx switch, active-high 	
37	I	EAN	 External address bus negative; must be pulled-down with 4.7 kOhm to GND System configuration pin along with P2_0 and P2_4 pins, used to set the module in any one of these modes: Application mode (for normal operation) Test mode (to change EEPROM values) Write Flash mode (to load a new firmware into the module), refer to Table 5-1 	
38	I/O	DM	Differential data-minus USB	
39	I/O	DP	Differential data-plus USB	
40	I/O	P3_6	Configurable control or indication pin (Internally pulled-up if configured as an input) Multi-SPK Master/Slave mode control (FW dependent)	
41	I/O	P3_3	Configurable control or indication pin (Internally pulled-up if configured as an input) FWD key (default), active-low	
42	I/O	P3_1	Configurable control or indication pin (Internally pulled-up if configured as an input) REV key (default), active-low	

TABLE 1-2: BM63 MODULE PIN DESCRIPTION (CONTINUED)

Pin No	Pin Type	Name	Description	
43	I/O	P0_2	Configurable control or indication pin (Internally pulled-up if configured as an input) Play/Pause key (default)	
44	I/O	P2_0	System configuration pin along with P2_4 and EAN pins use to set the module in one of these modes:	
			 Application mode (for normal operation) 	
			 Test mode (to change EEPROM values) 	
			 Write Flash mode (to load a new firmware into the mod- ule), refer to Table 5-1 	
			Pulse/PWM signal output	
45	I/O	P2_7	Configurable control or indication pin (Internally pulled-up if configured as an input) Volume-up key (default), active-low	
46	I/O	P3_0	Configurable control or indication pin (Internally pulled-up if configured as an input) AUX-In detector, active-low	
47	I/O	P0_5	Configurable control or indication pin (Internally pulled-up if configured as an input) Volume-down key (default), active-low	
48	P	GND	Ground reference	
Legend:	I= Input pin	O= Outpu	t pin I/O= Input/Output pin P= Power pin	

TABLE 1-2: BM63 MODULE PIN DESCRIPTION (CONTINUED)

Note: All I/O pins can be configured using the UI tool, a Windows utility.

2.0 AUDIO

The input and output audios have different stages and each stage can be programmed to vary the characteristics of the gain response. For microphones, both single-ended inputs and differential inputs are supported. To maintain a high quality signal, a stable bias voltage source to the condenser microphone's FET is provided. The DC blocking capacitors can be used at both positive and negative sides of a input. Internally, this analog signal is converted to 16-bit, 8/16 kHz linear PCM data.

2.1 Digital Signal Processor

A Digital Signal Processor (DSP) is used to perform speech and audio processing. The advanced speech features, such as acoustic echo cancellation and noise reduction are inbuilt. To reduce nonlinear distortion and to help echo cancellation, an outgoing signal level to the speaker is monitored and adjusted to avoid saturation of speaker output or microphone input. Adaptive filtering is also applied to track the echo path impulse in response to provide echo free and full-duplex user experience.

The embedded noise reduction algorithm helps to extract clean speech signals from the noisy input captured by the microphones, and improves mutual understanding in communication.

The advanced audio features, such as multi-band dynamic range control, parametric multi-band equalizer, audio widening and virtual bass are inbuilt. The audio effect algorithms improve the user's audio listening experience in terms of better audio quality after audio signal processing.

Figure 2-1 and Figure 2-2 illustrate the processing flow of speaker-phone applications for speech and audio signal processing.









Users can configure DSP parameters using the DSP tool. For additional information on the DSP tool, refer to the "*IS206X DSP Application Note*".

Note: The DSP tool and "*IS206X DSP Application Note*" document, are available for download from the Microchip web site at: www.microchip.com/BM63.

FIGURE 2-3: CODEC DAC DYNAMIC RANGE

2.2 Codec

The built-in codec has a high signal-to-noise ratio (SNR) performance and it consists of an ADC, a DAC and an additional analog circuitry.

Figure 2-3 through Figure 2-6 illustrate the dynamic range and frequency response of the codec.









FIGURE 2-5: CODEC DAC FREQUENCY RESPONSE (CAPLESS MODE)





2.3 Auxiliary Port

The BM63 module supports analog (line-in) signals from the external audio source. The analog (line-in) signal can be processed by the DSP to generate different sound effects (Multi-band dynamic range compression and audio widening), which can be configured by using the DSP tool.

2.4 Analog Speaker Output

The BM63 module supports the following analog speaker output modes:

- Capless mode Recommended for headphone applications in which capless output connection helps to save the BOM cost by avoiding a large DC blocking capacitor. Figure 2-7 illustrates the analog speaker output capless mode
- Single-ended mode Used for driving an external audio amplifier where a DC blocking capacitor is required. Figure 2-8 illustrates the analog speaker output single-ended mode

FIGURE 2-7: ANALOG SPEAKER OUTPUT CAPLESS MODE



FIGURE 2-8: ANALOG SPEAKER OUTPUT SINGLE-ENDED MODE



3.0 TRANSCEIVER

The BM63 module is designed and optimized for Bluetooth 2.4 GHz system. It contains a complete radio frequency transmitter/receiver section. An internal synthesizer generates a stable clock for synchronizing with another device.

3.1 Transmitter

The internal power amplifier (PA) has a maximum output power of +4 dBm. This is applied for Class 2 or Class 3 radios without an external RF PA.

The transmitter performs the IQ conversion to minimize the frequency drift.

3.2 Receiver

The low-noise amplifier (LNA) operates with TR-combined mode for single port application. It can save a pin on the package without having an external Tx/Rx switch.

The ADC can sample the input analog signal and convert it into a digital signal for demodulator analysis. A channel filter has been integrated into receiver channel before the ADC, which is used to reduce the external component count and increase the anti-interference capability.

The image rejection filter is used to reject the image frequency for low-IF architecture. This filter for low-IF architecture is intended to reduce external Band Pass Filter (BPF) component for a super heterodyne architecture.

The Received Signal Strength Indicator (RSSI) signal feedback to the processor is used to control the RF output power to make a good trade-off for effective distance and current consumption.

3.3 Synthesizer

A synthesizer generates a clock for radio transceiver operation. There is a VCO inside, with a tunable internal LC tank that can reduce variation for components. A crystal oscillator with an internal digital trimming circuit provides a stable clock for the synthesizer.

3.4 Modem

For Bluetooth 1.2 specification and below, 1 Mbps was the standard data rate based on the Gaussian Frequency Shift Keying (GFSK) modulation scheme. This basic rate modem meets Basic Data Rate (BDR) requirements of Bluetooth 2.0 with Enhanced Data Rate (EDR) specifications.

For Bluetooth 2.0 and above specifications, EDR has been introduced to provide the data rates of 1/2/3 Mbps. For baseband, both BDR and EDR utilize the same 1 MHz symbol rate and 1.6 kHz slot rate. For BDR, symbol 1 represents 1-bit. However, each sym-

bol in the payload part of EDR packets represents 2/3 bits. This is achieved by using two different modulations, $\pi/4$ DQPSK and 8 DPSK.

3.5 Adaptive Frequency Hopping (AFH)

The BM63 module has an AFH function to avoid RF interference. It has an algorithm to check the nearby interference and to choose clear channel for transceiver Bluetooth signal.

BM63

NOTES:

4.0 POWER MANAGEMENT UNIT

The on-chip Power Management Unit (PMU) has two main features: lithium-ion and lithium-polymer battery charger, and voltage regulator. A power switch is used to switch over the power source between the battery and an adapter. Also, the PMU provides current to drive three LEDs.

4.1 Charging a Battery

The BM63 module has a built-in battery charger which is optimized for lithium-ion and lithium-polymer batteries.

The battery charger includes a current sensor for charging control, user programmable current regulation and high accuracy voltage regulation.

The charging current parameters are configured by the UI tool. Reviving, pre-charging, constant current and constant voltage modes and re-charging functions are included. The maximum charging current is 350 mA. Figure 4-1 illustrates the charging curve of a battery.



FIGURE 4-1: BATTERY CHARGING CURVE

4.2 Voltage Monitoring

A 10-bit successive approximation register ADC (SAR ADC) provides a dedicated channel for battery voltage level detection. The warning level can be programmed by using the UI tool. The ADC provides a granular resolution to enable the external MCU to take control over the charging process.

4.3 LED Driver

Three dedicated LED drivers control the LEDs. They provide enough sink current (16 step control and 0.35 mA for each step), thus LEDs can be connected with the BM63 module. The LED settings can be configured using the UI tool.

Figure 4-2 illustrates the LED drivers in the BM63 module.

FIGURE 4-2: LED DRIVER



4.4 Under Voltage Protection

When the voltage of the SYS_PWR pin drops below the voltage level of 2.9V, the system will shutdown automatically.

5.0 APPLICATION INFORMATION

5.1 Host MCU Interface

The BM63 module supports UART commands. The UART commands enable an external MCU to control the BM63 module. Figure 5-1 illustrates the UART interface between the BM63 module and an external MCU.

FIGURE 5-1: HOST MCU INTERFACE OVER UART



An external MCU can control the BM63 module over the UART interface and wakeup the module with the MFB and P3_7 pins.

Refer to the *"UART_CommandSet"* document for a list of functions the BM63 module supports and how to use the UI tool to configure the UART and UART Command Set tool.

Note: The UART Command set tool (SPKCommandSetTool v160.xx) and "UART_CommandSet" document are available for download from the Microchip web site at: www.microchip.com/BM63.

Figure 5-2 through Figure 5-6 illustrate the timing sequences of various UART control signals.

FIGURE 5-2: POWER-ON/OFF SEQUENCE



BM63















5.2 I²S Mode Application

The BM63 module provides an I^2S digital audio output interface to connect with an external codec/DSP. It provides 8, 16, 44.1, 48, 88.2 and 96 kHz sampling rates for 16-bit and 24-bit data formats. The I^2S setting can be configured using the UI and DSP tools.

Figure 5-7 and Figure 5-8 illustrate the I²S signal connection between the BM63 module and an external DSP. Use the DSP tool to configure the BM63 module as a Master/Slave.

For additional information on timing specifications, refer to **8.2** "Timing specifications".

FIGURE 5-7:	BM63 MODULE IN I ² S MASTER MODE
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FIGURE 5-8: BM63 MODULE IN I²S SLAVE MODE

External DSP/ Codec		BM63	
BCLK DACLRC		SCLK0 RFS0	
ADCDAT		DR0	
DACDAT	•	DT0	

5.3 Reset

The BM63 module provides a watchdog timer (WDT) to reset the chip. It has an integrated Power-on Reset (POR) circuit that resets all circuits to a known Power-on state. This action can be driven by an external Reset signal which is used to control the device externally by forcing it into a POR state. The RST_N signal input is active-low and no connection is required in most of the applications.